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Details

Product Status	Obsolete
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	EBI/EMI, SMBus (2-Wire/I ² C), SPI, UART/USART
Peripherals	Cap Sense, POR, PWM, Temp Sensor, WDT
Number of I/O	54
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 16x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-TQFP
Supplier Device Package	64-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f710-gqr

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5. TQFP-48 Package Specifications

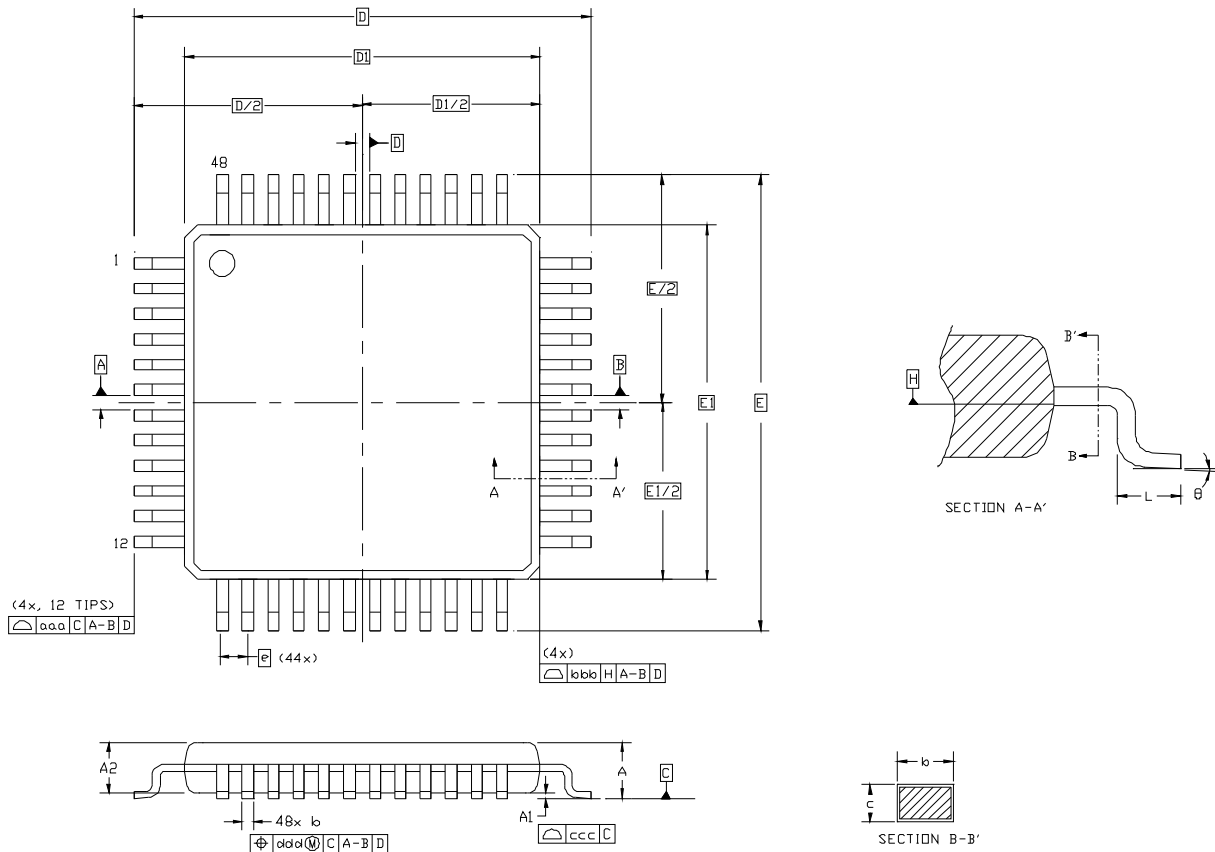


Figure 5.1. TQFP-48 Package Drawing

Table 5.1. TQFP-48 Package Dimensions

Dimension	Min	Nom	Max	Dimension	Min	Nom	Max
A	—	—	1.20	E	9.00 BSC.		
A1	0.05	—	0.15	E1	7.00 BSC.		
A2	0.95	1.00	1.05	L	0.45	0.60	0.75
b	0.17	0.22	0.27	aaa	0.20		
c	0.09	—	0.20	bbb	0.20		
D	9.00 BSC.			ccc	0.08		
D1	7.00 BSC.			ddd	0.08		
e	0.50 BSC.			Θ	0°	3.5°	7°

Notes:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. This drawing conforms to JEDEC outline MS-026, variation ABC.
4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.



Table 5.2. TQFP-48 PCB Land Pattern Dimensions

Dimension	Min	Max
C1	8.30	8.40
C2	8.30	8.40
E	0.50 BSC	
X1	0.20	0.30
Y1	1.40	1.50

Notes:

General

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. This land pattern design is based on the IPC-7351 guidelines.

Solder Mask Design

3. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 μm minimum, all the way around the pad.

Stencil Design

4. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
5. The stencil thickness should be 0.125 mm (5 mils).
6. The ratio of stencil aperture to land pad size should be 1:1 for all pads.

Card Assembly

7. A No-Clean, Type-3 solder paste is recommended.
8. The recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

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SFR Definition 10.2. ADC0H: ADC0 Data Word MSB

Bit	7	6	5	4	3	2	1	0
Name	ADC0H[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xBE; SFR Page = 0

Bit	Name	Function
7:0	ADC0H[7:0]	ADC0 Data Word High-Order Bits. For AD0LJST = 0: Bits 7:2 will read 000000b. Bits 1–0 are the upper 2 bits of the 10-bit ADC0 Data Word. For AD0LJST = 1: Bits 7:0 are the most-significant bits of the 10-bit ADC0 Data Word. Note: In 8-bit mode AD0LJST is ignored, and ADC0H holds the 8-bit data word.

SFR Definition 10.3. ADC0L: ADC0 Data Word LSB

Bit	7	6	5	4	3	2	1	0
Name	ADC0L[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xBD; SFR Page = 0

Bit	Name	Function
7:0	ADC0L[7:0]	ADC0 Data Word Low-Order Bits. For AD0LJST = 0: Bits 7:0 are the lower 8 bits of the 10-bit Data Word. For AD0LJST = 1: Bits 7:6 are the lower 2 bits of the 10-bit Data Word. Bits 5–0 will always read 0. Note: In 8-bit mode AD0LJST is ignored, and ADC0L will read back 00000000b.

15.9. Capacitive Sense Multiplexer

The input multiplexer can be controlled through two methods. The CS0MX register can be written to through firmware, or the register can be configured automatically using the modules auto-scan functionality (see “15.4. Automatic Scanning”).

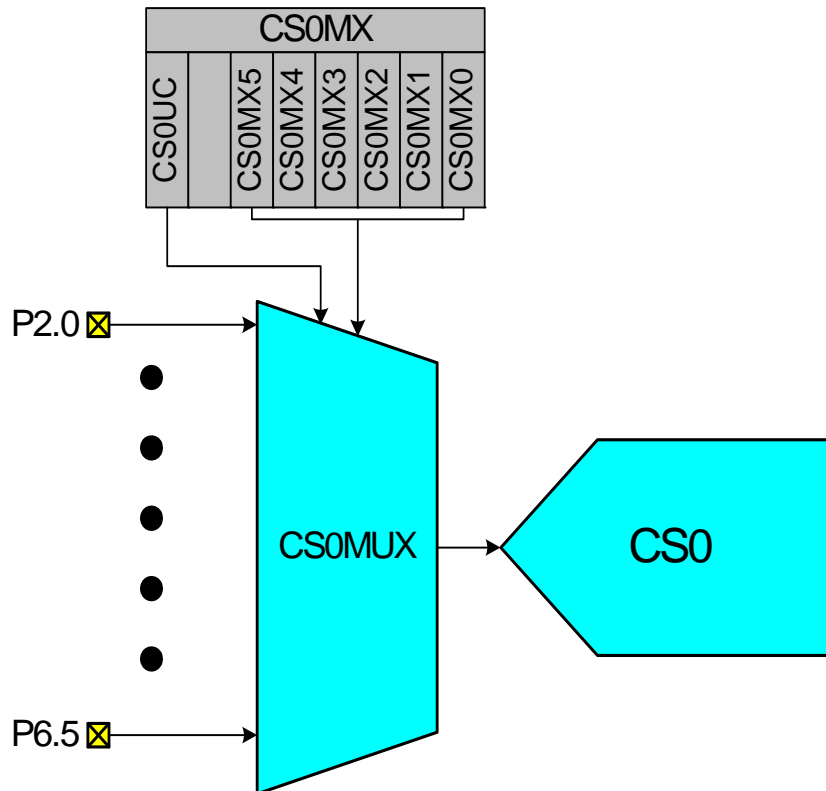


Figure 15.3. CS0 Multiplexer Block Diagram

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SFR Definition 16.3. SP: Stack Pointer

Bit	7	6	5	4	3	2	1	0
Name	SP[7:0]							
Type	R/W							
Reset	0	0	0	0	0	1	1	1

SFR Address = 0x81; SFR Page = All Pages

Bit	Name	Function
7:0	SP[7:0]	Stack Pointer. The Stack Pointer holds the location of the top of the stack. The stack pointer is incremented before every PUSH operation. The SP register defaults to 0x07 after reset.

SFR Definition 16.4. ACC: Accumulator

Bit	7	6	5	4	3	2	1	0
Name	ACC[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xE0; SFR Page = All Pages; Bit-Addressable

Bit	Name	Function
7:0	ACC[7:0]	Accumulator. This register is the accumulator for arithmetic operations.

Table 20.1. Special Function Register (SFR) Memory Map

Addr	SFR Page	0(8)	1(9)	2(A)	3(B)	4(C)	5(D)	6(E)	7(F)
F8	0 F	SPI0CN	PCA0L P0DRV	PCA0H P1DRV	PCA0CPL0 P2DRV	PCA0CPH0 P3DRV	P4DRV	P5DRV	VDM0CN
F0	0 F	B	P0MDIN	P1MDIN	P0MAT P2MDIN	P0MASK P3MDIN	P4MDIN	P5MDIN	P6MDIN
E8	0 F	ADC0CN	PCA0CPL1	PCA0CPH1	PCA0CPL2	PCA0CPH2 DERIVID	PCA0MD	EMI0TC	RSTSRC
E0	0 F	ACC	P1MAT XBR0	P1MASK XBR1	WDTCN	IT01CF		EIE1	EIE2
D8	0 F	PCA0CN	CRC0DATA	PCA0CPM0	PCA0CPM1	PCA0CPM2			
D0	0 F	PSW	EEDATA	REF0CN		P0SKIP	P1SKIP	P2SKIP	
C8	0 F	TMR2CN		TMR2RLL	TMR2RLH	TMR2L	TMR2H	EIP1	EIP2
C0	0 F	SMB0CN	SMB0CF P6DRV	SMB0DAT	ADC0GTL	ADC0GTH HWID	ADC0LTL EECNTL	ADC0LTH EEKEY	EMI0CF
B8	0 F	IP	REG0CN	SMB0ADR	ADC0MX SMB0ADM	ADC0CF	ADC0L CLKSEL	ADC0H CS0MD2	OSCICL
B0	0 F	P3		P6	P5		OSCXCN	EEADDR	FLKEY
A8	0 F	IE	CS0DL OSCICN	CS0DH EMI0CN		P4	CS0MD1 REVID		P3MDOUT
A0	0 F	P2	SPI0CFG PCA0PWM	SPI0CKR	SPI0DAT	P0MDOUT	P1MDOUT	P2MDOUT	SFRPAGE
98	0 F	SCON0	SBUF0	CS0CN P4MDOUT	CPT0CN P5MDOUT	CS0MX P6MDOUT	CPT0MD	CS0CF	CPT0MX CS0PM
90	0 F	P1	TMR3CN CRC0CN	TMR3RLL CS0SS	TMR3RLH CS0SE	TMR3L CRC0IN	TMR3H CRC0FLIP	CS0THL CRC0AUTO	CS0THH CRC0CNT
88	0 F	TCON	TMOD	TL0	TL1	TH0	TH1	CKCON	PSCTL
80	0 F	P0	SP	DPL	DPH				PCON
		0(8)	1(9)	2(A)	3(B)	4(C)	5(D)	6(E)	7(F)

Notes:

1. SFR addresses ending in 0x0 or 0x8 (leftmost column) are bit-addressable.
2. SFRs indicated with bold lettering and shaded cells are available on both SFR Page 0 and F.

Table 20.2. Special Function Registers (Continued)

SFRs are listed in alphabetical order. All undefined SFR locations are reserved

Register	Address	Page	Description	Page
CS0CN	0x9A	0	CS0 Control	88
CS0DH	0xAA	0	CS0 Data High	90
CS0DL	0xA9	0	CS0 Data Low	90
CS0CF	0x9E	0	CS0 Configuration	89
CS0MD1	0xAD	0	CS0 Mode 1	94
CS0MD2	0xBE	F	CS0 Mode 2	95
CS0MX	0x9C	0	CS0 Mux	97
CS0PM	0x9F	F	CS0 Pin Monitor	93
CS0SE	0x93	F	Auto Scan End Channel	91
CS0SS	0x92	F	Auto Scan Start Channel	91
CS0THH	0x97	0	CS0 Digital Compare Threshold High	92
CS0THL	0x96	0	CS0 Digital Compare Threshold Low	92
DERIVID	0xEC	F	Derivative Identification	128
DPH	0x83	All Pages	Data Pointer High	104
DPL	0x82	All Pages	Data Pointer Low	104
EEADDR	0xB6	All Pages	EEPROM Byte Address	156
EECNTL	0xC5	F	EEPROM Control	158
EEDATA	0xD1	All Pages	EEPROM Byte Data	157
EEKEY	0xC6	F	EEPROM Protect Key	159
EIE1	0xE6	All Pages	Extended Interrupt Enable 1	142
EIE2	0xE7	All Pages	Extended Interrupt Enable 2	143
EIP1	0xCE	F	Extended Interrupt Priority 1	144
EIP2	0xCF	F	Extended Interrupt Priority 2	145
EMI0CF	0xC7	F	EMIF Configuration	114
EMI0CN	0xAA	F	EMIF Control	113
EMI0TC	0xEE	F	EMIF Timing Control	119
FLKEY	0xB7	All Pages	Flash Lock And Key	154
HWID	0xC4	F	Hardware Identification	128
IE	0xA8	All Pages	Interrupt Enable	140
IP	0xB8	All Pages	Interrupt Priority	141
IT01CF	0xE4	F	INT0/INT1 Configuration	147
OSCICL	0xBF	F	Internal Oscillator Calibration	173
OSICN	0xA9	F	Internal Oscillator Control	174
OSXCXN	0xB5	F	External Oscillator Control	176
P0	0x80	All Pages	Port 0 Latch	195
P0DRV	0xF9	F	Port 0 Drive Strength	197
P0MASK	0xF4	0	Port 0 Mask	192
P0MAT	0xF3	0	Port 0 Match	193

6. Using the MOVX instruction, write a data byte to any location within the 512-byte page to be erased.
7. Clear the PSWE and PSEE bits.
8. Restore previous interrupt state.

Steps 4–6 must be repeated for each 512-byte page to be erased.

Note: Flash security settings may prevent erasure of some Flash pages, such as the reserved area and the page containing the lock bytes. For a summary of Flash security settings and restrictions affecting Flash erase operations, please see Section “22.3. Security Options” on page 149.

22.1.3. Flash Write Procedure

A write to Flash memory can clear bits to logic 0 but cannot set them; only an erase operation can set bits to logic 1 in Flash. **A byte location to be programmed should be erased before a new value is written.**

The recommended procedure for writing a single byte in Flash is as follows:

1. Save current interrupt state and disable interrupts.
2. Ensure that the Flash byte has been erased (has a value of 0xFF).
3. Set the PSWE bit (register PSCTL).
4. Clear the PSEE bit (register PSCTL).
5. Write the first key code to FLKEY: 0xA5.
6. Write the second key code to FLKEY: 0xF1.
7. Using the MOVX instruction, write a single data byte to the desired location within the 512-byte sector.
8. Clear the PSWE bit.
9. Restore previous interrupt state.

Steps 5–7 must be repeated for each byte to be written.

Note: Flash security settings may prevent writes to some areas of Flash, such as the reserved area. For a summary of Flash security settings and restrictions affecting Flash write operations, please see Section “22.3. Security Options” on page 149.

22.2. Non-volatile Data Storage

The Flash memory can be used for non-volatile data storage as well as program code. This allows data such as calibration coefficients to be calculated and stored at run time. Data is written using the MOVX write instruction and read using the MOVC instruction.

Note: MOVX read instructions always target XRAM.

22.3. Security Options

The CIP-51 provides security options to protect the Flash memory from inadvertent modification by software as well as to prevent the viewing of proprietary program code and constants. The Program Store Write Enable (bit PSWE in register PSCTL) and the Program Store Erase Enable (bit PSEE in register PSCTL) bits protect the Flash memory from accidental modification by software. PSWE must be explicitly set to 1 before software can modify the Flash memory; both PSWE and PSEE must be set to 1 before software can erase Flash memory. Additional security features prevent proprietary program code and data constants from being read or altered across the C2 interface.

A Security Lock Byte located at the last byte of Flash user space offers protection of the Flash program memory from access (reads, writes, and erases) by unprotected code or the C2 interface. The Flash security mechanism allows the user to lock all Flash pages, starting at page 0, by writing a non-0xFF value to the lock byte. **Note that writing a non-0xFF value to the lock byte will lock all pages of FLASH from reads, writes, and erases, including the page containing the lock byte.**

The level of Flash security depends on the Flash access method. The three Flash access methods that can be restricted are reads, writes, and erases from the C2 debug interface, user firmware executing on

24. Power Management Modes

The C8051F70x/71x devices have three software programmable power management modes: Idle, Stop, and Suspend. Idle mode and Stop mode are part of the standard 8051 architecture, while Suspend mode is an enhanced power-saving mode implemented by the high-speed oscillator peripheral.

Idle mode halts the CPU while leaving the peripherals and clocks active. In Stop mode, the CPU is halted, all interrupts and timers (except the Missing Clock Detector) are inactive, and the internal oscillator is stopped (analog peripherals remain in their selected states; the external oscillator is not affected). Suspend mode is similar to Stop mode in that the internal oscillator and CPU are halted, but the device can wake on events such as a Port Mismatch, Comparator low output, or a Timer 3 overflow. Since clocks are running in Idle mode, power consumption is dependent upon the system clock frequency and the number of peripherals left in active mode before entering Idle. Stop mode and Suspend mode consume the least power because the majority of the device is shut down with no clocks active. SFR Definition 24.1 describes the Power Control Register (PCON) used to control the C8051F70x/71x's Stop and Idle power management modes. Suspend mode is controlled by the SUSPEND bit in the OSCICN register (SFR Definition 27.3).

Although the C8051F70x/71x has Idle, Stop, and Suspend modes available, more control over the device power can be achieved by enabling/disabling individual peripherals as needed. Each analog peripheral can be disabled when not in use and placed in low power mode. Digital peripherals, such as timers or serial buses, draw little power when they are not in use. Turning off oscillators lowers power consumption considerably, at the expense of reduced functionality.

24.1. Idle Mode

Setting the Idle Mode Select bit (PCON.0) causes the hardware to halt the CPU and enter Idle mode as soon as the instruction that sets the bit completes execution. All internal registers and memory maintain their original data. All analog and digital peripherals can remain active during Idle mode.

Idle mode is terminated when an enabled interrupt is asserted or a reset occurs. The assertion of an enabled interrupt will cause the Idle Mode Selection bit (PCON.0) to be cleared and the CPU to resume operation. The pending interrupt will be serviced and the next instruction to be executed after the return from interrupt (RETI) will be the instruction immediately following the one that set the Idle Mode Select bit. If Idle mode is terminated by an internal or external reset, the CIP-51 performs a normal reset sequence and begins program execution at address 0x0000.

Note: If the instruction following the write of the IDLE bit is a single-byte instruction and an interrupt occurs during the execution phase of the instruction that sets the IDLE bit, the CPU may not wake from Idle mode when a future interrupt occurs. Therefore, instructions that set the IDLE bit should be followed by an instruction that has two or more opcode bytes, for example:

```
// in 'C':
PCON |= 0x01;           // set IDLE bit
PCON = PCON;           // ... followed by a 3-cycle dummy instruction

; in assembly:
ORL PCON, #01h          ; set IDLE bit
MOV PCON, PCON          ; ... followed by a 3-cycle dummy instruction
```

If enabled, the Watchdog Timer (WDT) will eventually cause an internal watchdog reset and thereby terminate the Idle mode. This feature protects the system from an unintended permanent shutdown in the event of an inadvertent write to the PCON register. If this behavior is not desired, the WDT may be disabled by software prior to entering the Idle mode if the WDT was initially configured to allow this operation. This provides the opportunity for additional power savings, allowing the system to remain in the Idle mode indefinitely, waiting for an external stimulus to wake up the system. Refer to Section “26. Watchdog Timer” on page 169 for more information on the use and configuration of the WDT.

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SFR Definition 27.1. CLKSEL: Clock Select

Bit	7	6	5	4	3	2	1	0
Name	CLKRDY	CLKDIV[2:0]			Reserved	CLKSEL[2:0]		
Type	R	R/W	R/W	R/W	R	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xBD; SFR Page= F

Bit	Name	Function
7	CLKRDY	System Clock Divider Clock Ready Flag. 0: The selected clock divide setting has not been applied to the system clock. 1: The selected clock divide setting has been applied to the system clock.
6:4	CLKDIV	System Clock Divider Bits. Selects the clock division to be applied to the selected source (internal or external). 000: Selected clock is divided by 1. 001: Selected clock is divided by 2. 010: Selected clock is divided by 4. 011: Selected clock is divided by 8. 100: Selected clock is divided by 16. 101: Selected clock is divided by 32. 110: Selected clock is divided by 64. 111: Selected clock is divided by 128.
3	Reserved	Read = 0b. Must write 0b.
2:0	CLKSEL[2:0]	System Clock Select. Selects the oscillator to be used as the undivided system clock source. 000: Internal Oscillator 001: External Oscillator All other values reserved.

Table 30.5. SMBus Status Decoding: Hardware ACK Disabled (EHACK = 0)

Mode	Values Read				Current SMBus State	Typical Response Options	Values to Write			Next Status Vector Expected
	Status Vector	ACKRQ	ARBLOST	ACK			STA	STO	ACK	
Master Transmitter	1110	0	0	X	A master START was generated.	Load slave address + R/W into SMB0DAT.	0	0	X	1100
	1100	0	0	0	A master data or address byte was transmitted; NACK received.	Set STA to restart transfer.	1	0	X	1110
						Abort transfer.	0	1	X	—
		0	0	1	A master data or address byte was transmitted; ACK received.	Load next data byte into SMB0DAT.	0	0	X	1100
						End transfer with STOP.	0	1	X	—
						End transfer with STOP and start another transfer.	1	1	X	—
						Send repeated START.	1	0	X	1110
						Switch to Master Receiver Mode (clear SI without writing new data to SMB0DAT).	0	0	X	1000
	1000	1	0	X	A master data byte was received; ACK requested.	Acknowledge received byte; Read SMB0DAT.	0	0	1	1000
						Send NACK to indicate last byte, and send STOP.	0	1	0	—
						Send NACK to indicate last byte, and send STOP followed by START.	1	1	0	1110
						Send ACK followed by repeated START.	1	0	1	1110
						Send NACK to indicate last byte, and send repeated START.	1	0	0	1110
						Send ACK and switch to Master Transmitter Mode (write to SMB0DAT before clearing SI).	0	0	1	1100
						Send NACK and switch to Master Transmitter Mode (write to SMB0DAT before clearing SI).	0	0	0	1100

31.1. Signal Descriptions

The four signals used by SPI0 (MOSI, MISO, SCK, NSS) are described below.

31.1.1. Master Out, Slave In (MOSI)

The master-out, slave-in (MOSI) signal is an output from a master device and an input to slave devices. It is used to serially transfer data from the master to the slave. This signal is an output when SPI0 is operating as a master and an input when SPI0 is operating as a slave. Data is transferred most-significant bit first. When configured as a master, MOSI is driven by the MSB of the shift register in both 3- and 4-wire mode.

31.1.2. Master In, Slave Out (MISO)

The master-in, slave-out (MISO) signal is an output from a slave device and an input to the master device. It is used to serially transfer data from the slave to the master. This signal is an input when SPI0 is operating as a master and an output when SPI0 is operating as a slave. Data is transferred most-significant bit first. The MISO pin is placed in a high-impedance state when the SPI module is disabled and when the SPI operates in 4-wire mode as a slave that is not selected. When acting as a slave in 3-wire mode, MISO is always driven by the MSB of the shift register.

31.1.3. Serial Clock (SCK)

The serial clock (SCK) signal is an output from the master device and an input to slave devices. It is used to synchronize the transfer of data between the master and slave on the MOSI and MISO lines. SPI0 generates this signal when operating as a master. The SCK signal is ignored by a SPI slave when the slave is not selected (NSS = 1) in 4-wire slave mode.

31.1.4. Slave Select (NSS)

The function of the slave-select (NSS) signal is dependent on the setting of the NSSMD1 and NSSMD0 bits in the SPI0CN register. There are three possible modes that can be selected with these bits:

1. NSSMD[1:0] = 00: 3-Wire Master or 3-Wire Slave Mode: SPI0 operates in 3-wire mode, and NSS is disabled. When operating as a slave device, SPI0 is always selected in 3-wire mode. Since no select signal is present, SPI0 must be the only slave on the bus in 3-wire mode. This is intended for point-to-point communication between a master and one slave.
2. NSSMD[1:0] = 01: 4-Wire Slave or Multi-Master Mode: SPI0 operates in 4-wire mode, and NSS is enabled as an input. When operating as a slave, NSS selects the SPI0 device. When operating as a master, a 1-to-0 transition of the NSS signal disables the master function of SPI0 so that multiple master devices can be used on the same SPI bus.
3. NSSMD[1:0] = 1x: 4-Wire Master Mode: SPI0 operates in 4-wire mode, and NSS is enabled as an output. The setting of NSSMD0 determines what logic level the NSS pin will output. This configuration should only be used when operating SPI0 as a master device.

See Figure 31.2, Figure 31.3, and Figure 31.4 for typical connection diagrams of the various operational modes. **Note that the setting of NSSMD bits affects the pinout of the device.** When in 3-wire master or 3-wire slave mode, the NSS pin will not be mapped by the crossbar. In all other modes, the NSS signal will be mapped to a pin on the device. See Section “28. Port Input/Output” on page 180 for general purpose port I/O and crossbar information.

31.2. SPI0 Master Mode Operation

A SPI master device initiates all data transfers on a SPI bus. SPI0 is placed in master mode by setting the Master Enable flag (MSTEN, SPI0CN.6). Writing a byte of data to the SPI0 data register (SPI0DAT) when in master mode writes to the transmit buffer. If the SPI shift register is empty, the byte in the transmit buffer is moved to the shift register, and a data transfer begins. The SPI0 master immediately shifts out the data serially on the MOSI line while providing the serial clock on SCK. The SPIF (SPI0CN.7) flag is set to logic

31.4. SPI0 Interrupt Sources

When SPI0 interrupts are enabled, the following four flags will generate an interrupt when they are set to logic 1:

All of the following bits must be cleared by software.

- The SPI Interrupt Flag, SPIF (SPI0CN.7) is set to logic 1 at the end of each byte transfer. This flag can occur in all SPI0 modes.
- The Write Collision Flag, WCOL (SPI0CN.6) is set to logic 1 if a write to SPI0DAT is attempted when the transmit buffer has not been emptied to the SPI shift register. When this occurs, the write to SPI0DAT will be ignored, and the transmit buffer will not be written. This flag can occur in all SPI0 modes.
- The Mode Fault Flag MODF (SPI0CN.5) is set to logic 1 when SPI0 is configured as a master, and for multi-master mode and the NSS pin is pulled low. When a Mode Fault occurs, the MSTEN and SPIEN bits in SPI0CN are set to logic 0 to disable SPI0 and allow another master device to access the bus.
- The Receive Overrun Flag RXOVRN (SPI0CN.4) is set to logic 1 when configured as a slave, and a transfer is completed and the receive buffer still holds an unread byte from a previous transfer. The new byte is not transferred to the receive buffer, allowing the previously received data byte to be read. The data byte which caused the overrun is lost.

31.5. Serial Clock Phase and Polarity

Four combinations of serial clock phase and polarity can be selected using the clock control bits in the SPI0 Configuration Register (SPI0CFG). The CKPHA bit (SPI0CFG.5) selects one of two clock phases (edge used to latch the data). The CKPOL bit (SPI0CFG.4) selects between an active-high or active-low clock. Both master and slave devices must be configured to use the same clock phase and polarity. SPI0 should be disabled (by clearing the SPIEN bit, SPI0CN.0) when changing the clock phase or polarity. The clock and data line relationships for master mode are shown in Figure 31.5. For slave mode, the clock and data relationships are shown in Figure 31.6 and Figure 31.7. CKPHA should be set to 0 on both the master and slave SPI when communicating between two Silicon Labs C8051 devices.

The SPI0 Clock Rate Register (SPI0CKR) as shown in SFR Definition 31.3 controls the master mode serial clock frequency. This register is ignored when operating in slave mode. When the SPI is configured as a master, the maximum data transfer rate (bits/sec) is one-half the system clock frequency or 12.5 MHz, whichever is slower. When the SPI is configured as a slave, the maximum data transfer rate (bits/sec) for full-duplex operation is 1/10 the system clock frequency, provided that the master issues SCK, NSS (in 4-wire slave mode), and the serial input data synchronously with the slave's system clock. If the master issues SCK, NSS, and the serial input data asynchronously, the maximum data transfer rate (bits/sec) must be less than 1/10 the system clock frequency. In the special case where the master only wants to transmit data to the slave and does not need to receive data from the slave (i.e., half-duplex operation), the SPI slave can receive data at a maximum data transfer rate (bits/sec) of 1/4 the system clock frequency. This is provided that the master issues SCK, NSS, and the serial input data synchronously with the slave's system clock.

32. UART0

UART0 is an asynchronous, full duplex serial port offering modes 1 and 3 of the standard 8051 UART. Enhanced baud rate support allows a wide range of clock sources to generate standard baud rates (details in Section “32.1. Enhanced Baud Rate Generation” on page 255). Received data buffering allows UART0 to start reception of a second incoming data byte before software has finished reading the previous data byte.

UART0 has two associated SFRs: Serial Control Register 0 (SCON0) and Serial Data Buffer 0 (SBUF0). The single SBUF0 location provides access to both transmit and receive registers. **Writes to SBUF0 always access the Transmit register. Reads of SBUF0 always access the buffered Receive register; it is not possible to read data from the Transmit register.**

With UART0 interrupts enabled, an interrupt is generated each time a transmit is completed (TI0 is set in SCON0), or a data byte has been received (RI0 is set in SCON0). The UART0 interrupt flags are not cleared by hardware when the CPU vectors to the interrupt service routine. They must be cleared manually by software, allowing software to determine the cause of the UART0 interrupt (transmit complete or receive complete).

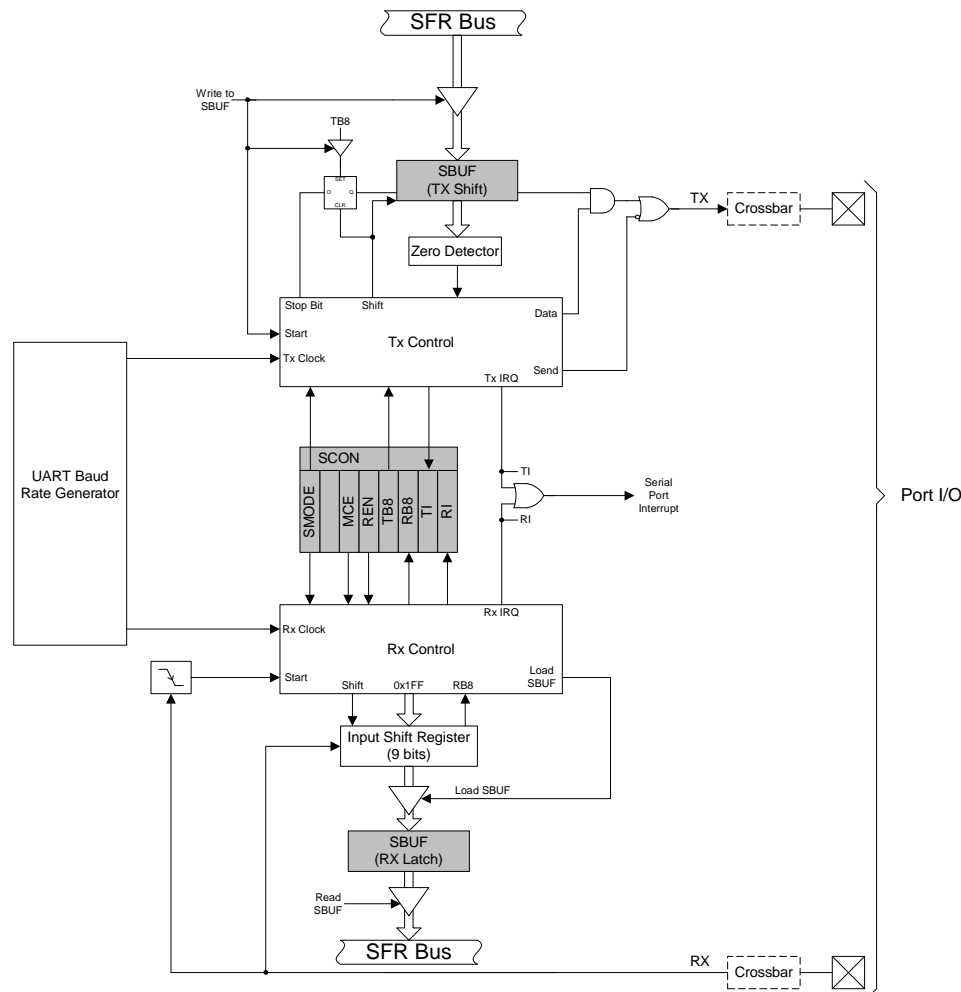


Figure 32.1. UART0 Block Diagram

32.2. Operational Modes

UART0 provides standard asynchronous, full duplex communication. The UART mode (8-bit or 9-bit) is selected by the S0MODE bit (SCON0.7). Typical UART connection options are shown in Figure 32.3.

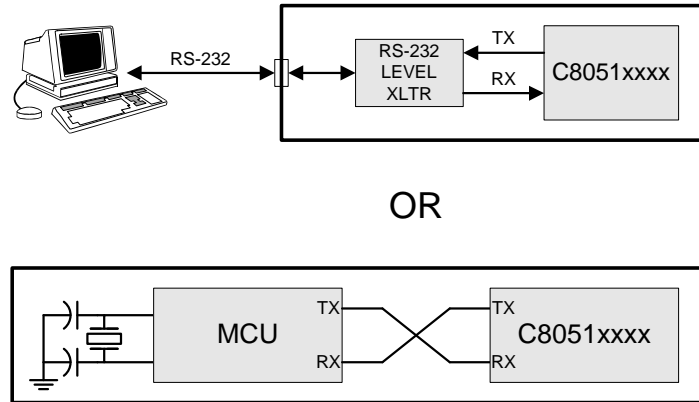


Figure 32.3. UART Interconnect Diagram

32.2.1. 8-Bit UART

8-Bit UART mode uses a total of 10 bits per data byte: one start bit, eight data bits (LSB first), and one stop bit. Data are transmitted LSB first from the TX0 pin and received at the RX0 pin. On receive, the eight data bits are stored in SBUF0 and the stop bit goes into RB80 (SCON0.2).

Data transmission begins when software writes a data byte to the SBUF0 register. The TI0 Transmit Interrupt Flag (SCON0.1) is set at the end of the transmission (the beginning of the stop-bit time). Data reception can begin any time after the REN0 Receive Enable bit (SCON0.4) is set to logic 1. After the stop bit is received, the data byte will be loaded into the SBUF0 receive register if the following conditions are met: RI0 must be logic 0, and if MCE0 is logic 1, the stop bit must be logic 1. In the event of a receive data overrun, the first received 8 bits are latched into the SBUF0 receive register and the following overrun data bits are lost.

If these conditions are met, the eight bits of data is stored in SBUF0, the stop bit is stored in RB80 and the RI0 flag is set. If these conditions are not met, SBUF0 and RB80 will not be loaded and the RI0 flag will not be set. An interrupt will occur if enabled when either TI0 or RI0 is set.

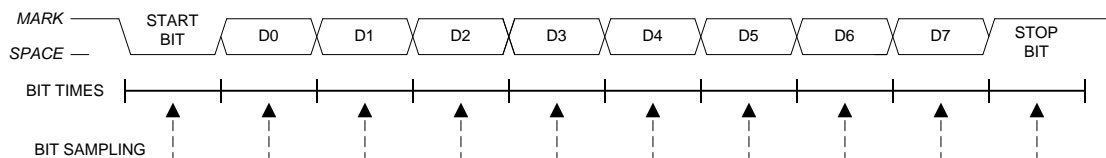


Figure 32.4. 8-Bit UART Timing Diagram

33.3.2. 8-bit Timers with Auto-Reload

When T3SPLIT is set, Timer 3 operates as two 8-bit timers (TMR3H and TMR3L). Both 8-bit timers operate in auto-reload mode as shown in Figure 33.8. TMR3RLL holds the reload value for TMR3L; TMR3RLH holds the reload value for TMR3H. The TR3 bit in TMR3CN handles the run control for TMR3H. TMR3L is always running when configured for 8-bit Mode. Timer 3 can also be used in capture mode to capture rising edges of the Comparator 0 output.

Each 8-bit timer may be configured to use SYSCLK, SYSCLK divided by 12, or the external oscillator clock source divided by 8. The Timer 3 clock select bits (T3MH and T3ML in CKCON) select either SYSCLK or the clock defined by the Timer 3 External Clock Select bits (T3XCLK in TMR3CN), as follows:

T3MH	T3XCLK	TMR3H Clock Source
0	0	SYSCLK / 12
0	1	External Clock / 8
1	X	SYSCLK

T3ML	T3XCLK	TMR3L Clock Source
0	0	SYSCLK / 12
0	1	External Clock / 8
1	X	SYSCLK

The TF3H bit is set when TMR3H overflows from 0xFF to 0x00; the TF3L bit is set when TMR3L overflows from 0xFF to 0x00. When Timer 3 interrupts are enabled, an interrupt is generated each time TMR3H overflows. If Timer 3 interrupts are enabled and TF3LEN (TMR3CN.5) is set, an interrupt is generated each time either TMR3L or TMR3H overflows. When TF3LEN is enabled, software must check the TF3H and TF3L flags to determine the source of the Timer 3 interrupt. The TF3H and TF3L interrupt flags are not cleared by hardware and must be manually cleared by software.

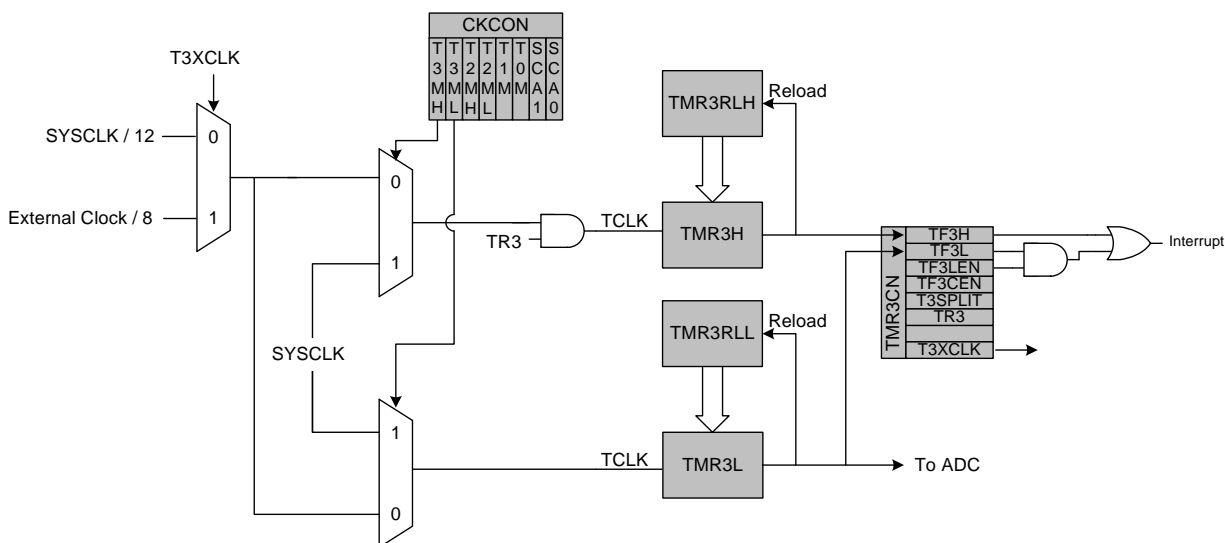


Figure 33.8. Timer 3 8-Bit Mode Block Diagram

C8051F70x/71x

34.4. Register Descriptions for PCA0

Following are detailed descriptions of the special function registers related to the operation of the PCA.

SFR Definition 34.1. PCA0CN: PCA Control

Bit	7	6	5	4	3	2	1	0
Name	CF	CR				CCF2	CCF1	CCF0
Type	R/W	R/W	R	R	R	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xD8; SFR Page = All Pages; Bit-Addressable

Bit	Name	Function
7	CF	PCA Counter/Timer Overflow Flag. Set by hardware when the PCA Counter/Timer overflows from 0xFFFF to 0x0000. When the Counter/Timer Overflow (CF) interrupt is enabled, setting this bit causes the CPU to vector to the PCA interrupt service routine. This bit is not automatically cleared by hardware and must be cleared by software.
6	CR	PCA Counter/Timer Run Control. This bit enables/disables the PCA Counter/Timer. 0: PCA Counter/Timer disabled. 1: PCA Counter/Timer enabled.
5:3	Unused	Read = 000b; Write = Don't care
2:0	CCF[2:0]	PCA Module n Capture/Compare Flag. These bits are set by hardware when a match or capture occurs in the associated PCA Module n. When the CCFn interrupt is enabled, setting this bit causes the CPU to vector to the PCA interrupt service routine. This bit is not automatically cleared by hardware and must be cleared by software.

DOCUMENT CHANGE LIST

Revision 0.5 to Revision 1.0

- Updated “Electrical Characteristics” on page 47.
- Updated “Port Input/Output” on page 180.

Revision 0.4 to Revision 0.5

- Removed Incorrect Pin Connections in Figure 1.4 on page 21 and Figure 1.6 on page 23.
- Updated Specifications in Section “9. Electrical Characteristics” on page 47.
- Updated Section “15. Capacitive Sense (CS0)” on page 80 for clarity.
- Corrected “CJNE A, direct, rel” instruction timing in Table 16.1.
- Noted that a minimum SYSCLK speed is required for Flash writes or erases in Section “22.1. Programming The Flash Memory” on page 148, and for EEPROM writes in Section “23.3. Interfacing with the EEPROM” on page 155.
- Corrected P0.3 overvoltage capabilities throughout document.

Revision 0.3 to Revision 0.4

- Updated Section “15. Capacitive Sense (CS0)” on page 80 to reflect Revision B enhancements.
- Added C8051F716 and C8051F717 devices, package information, and features.
- Updated Register 19.1, “HWID: Hardware Identification Byte,” on page 128.
- Corrected minor typographical and formatting errors throughout document.

Revision 0.2 to Revision 0.3

- Corrected Dimension D in the QFN-48 Package Specifications.
- Updated Table 9.1 on page 47.
- Updated Register 10.1, “ADC0CF: ADC0 Configuration,” on page 59.
- Updated Register 14.3, “CPT0MX: Comparator0 MUX Selection,” on page 79.
- Updated Section “28.1.1. Port Pins Configured for Analog I/O” on page 181.
- Updated Register 35.2, “DEVICEID: C2 Device ID,” on page 302.